SPECIFICATIONS

CUSTOMER . CES008

SAMPLE CODE · SH480272T-005-I09Q

MASS PRODUCTION CODE . PH480272T-005-109Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 005

DRAWING NO. (Ver.) . LMD-PH480272T-005-I09Q (Ver.003)

PACKAGING NO. (Ver.) PKG-PH480272T-005-l09Q (Ver.001)

Customer Approved

Date:

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Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
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03/11/2010	01	004	Modify Optical Characteristics	6	Poly
12/16/2010	01	005	Modify 1.5 Optical Characteristics	6	Timter
				~	

Total: 26 Page



Contents

1. SPECIFICATIONS

- 1.1 Features
- 1.2 Mechanical Specifications
- 1.3 Absolute Maximum Ratings
- 1.4 DC Electrical Characteristics
- 1.5 Optical Characteristics
- 1.6 Backlight Characteristics

2. MODULE STRUCTURE

- 2.1 Counter Drawing
- 2.2 Interface Pin Description
- 2.3 Timing Characteristics
 - 2.3.1 8080 Mode
 - 2.3.2 6800 Mode

3. QUALITY ASSURANCE SYSTEM

- 3.1 Quality Assurance Flow Chart
- 3.2 Inspection Specification

4. RELIABILITY TEST

4.1 Reliability Test Condition

5. PRECAUTION RELATING PRODUCT HANDLING

- 5.1 Safety
- 5.2 Handling
- 5.3 Storage
- 5.4 Terms of Warranty

Appendix : LCM Drawing

Packaging

Note: For detailed information please refer to IC data sheet: SOLOMON --- SSD1963



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	480 * 3 (RGB) * 272 Dots
LCD Type	a-Si TFT , Normally white , Transmissive type
Screen size (inch)	4.3 inch
Viewing Direction	6 O'clock
Color configuration	RGB-Strip
Backlight Type	LED B/L
Weight	70 g
Interface	Support 16-bit Parallel interface with 8080 or 6800 series MCU
Other (controller/driver IC)	SSD1963 / HX8257-A (Or Compatible IC)
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web side :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	105.5(W) x 67.2 (L) x 8.0(H)	mm

LCD panel

Item	Standard Value	Unit
Viewing Area	96.64 (W) x 55.456 (H)	mm
Active Area	95.04 (W) x 53.856 (L)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

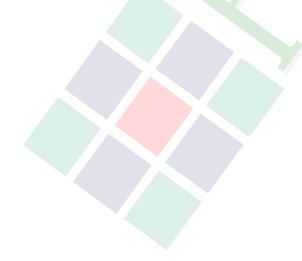
Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VDDIO	VSS=0	-0.5	4.6	V
Input Voltage	VI	_	-0.5	4.6	V
Operating Temperature	T_OP		-20	70	°C
Storage Temperature	T_{ST}	-	-30	80	°C

1.4 DC Electrical Characteristics

Module VSS = 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	VDDIO		3.0	3.3	3.6	V
Input H/L Level Voltage	VIH	-	0.8VDDIO	_	_	V
Input 17/L Level voltage	VIL		-	_	0.2VDDIO	V
Output H/L Level Voltag	VOH	-	0.8VDDIO	_	_	V
Output H/L Level voltag	VOL	-			0.2VDDIO	V
Supply Current	I _{DDIO}	VDDIO = 3.3 V Pattern= full display*1		250	350	mA

Note1: Maximum current display





1.5 Optical Characteristics

TFT LCD Module

VDDIO= 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	\
Response time	Tr+Tf	25 °C	_	_	36	54	ms	//-
	Тор	θΥ+		_	60			
Viowing angle	Bottom	θΥ-	CR ≥ 10		50		Dog	Note 4
Viewing angle	Left	θX-	UR ≥ 10		60	_	Deg.	NOLE 4
	Right	θX+			60			
Contrast rati	0	CR		200	250	_		Note 3
	White	X		0.28	0.33	0.38	Ne	
	vviile	Υ	Ta = 25°C θX , θY = 0°	0.32	0.37	0.42		Note1
	Red	Х		0.57	0.62	0.67		
Color of CIE Coordinate	Reu	Υ		0.31	0.36	0.41		
(With B/L)	Green	Х	ολ, στ – σ	0.29	0.34	0.39		NOLET
- /		Y		0.53	0.58	0.63		
	Pluo	Х		0.09	0.14	0.19		
	Blue	Y		0.08	0.13	0.18		
Average Brightr	ness							
Pattern=white display		IV	IF= 20 mA	340	420		cd/m ²	Note1
(With LCD)*1								
Uniformity		ΛB	IF= 20 mA	70			%	Note1
(With LCD)*	2	Δb	11 – 20 IIIA	70			70	NOLE



Note 1:

*1 : △B=B(min) / B(max) * 100%

*2 : Measurement Condition for Optical Characteristics:

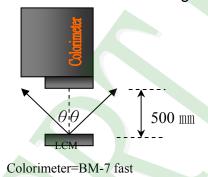
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500 ± 50 mm \rightarrow ($\theta = 0^{\circ}$)

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





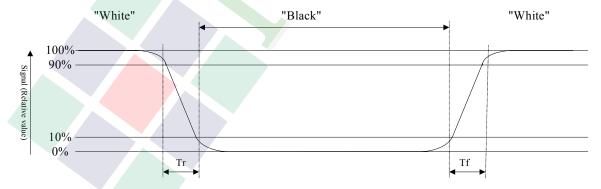
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

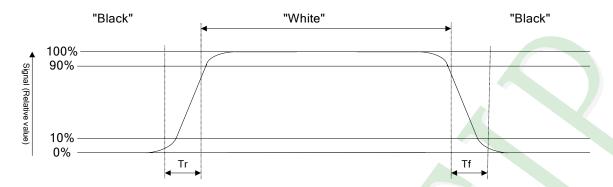
Refer to figure as below:

Normally White





Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

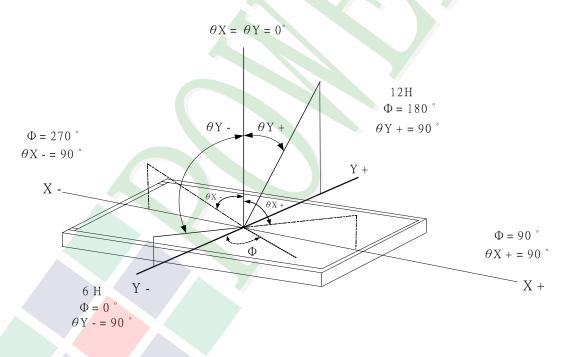
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

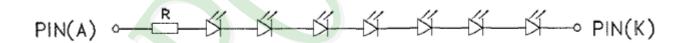
Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	_	25	mA
Reverse Voltage	VR	Ta =25°ℂ	_	5	V
Power Dissipation	Pd	Ta =25°ℂ	- ^	525	mW

Backlight Characteristics

	I					
Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF			22.8	_	V
Average Brightness (Without LCD) *1	IV	IF- 20 A	3850	4250	-	cd/m ²
CIE Color Coordinate*1	X	IF= 20 mA	0.285	0.315	0.345	_
(Without LCD)	Y		0.282	0.312	0.342	
Uniformity *1	∆B		80	-	_	%*2
Color			White	>		

*1 : This value will be changed while mass production.

*2 : △B=B(min) / B(max)%





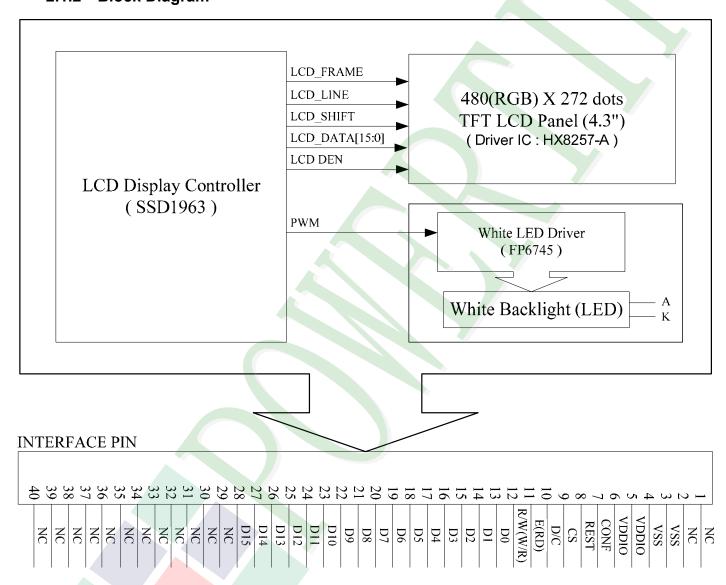
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

Pin No.	Symbol	Function
1	NC	Not Connect
2	NC	Not Connect
3	VSS	Ground
4	VSS	Ground
5	VDDIO	Power Supply Voltage.
6	VDDIO	Power Supply Voltage.
7	CONF	MCU interface configuration 0: 6800 Interface 1: 8080 Interface
8	RESET	Master synchronize reset.
9	CS	Chip select.
10	D/C	Data/Command select.
11	E (RD)	6800 mode: E (enable signal) 8080 mode: RD (read strobe signal)
12	R/W (W/R)	6800 mode: R/W 0: Write cycle 1: Read cycle 8080 mode: WR (write strobe signal)
13	D0	Data bus.
14	D1	Data bus.
15	D2	Data bus.
16	D3	Data bus.
17	D4	Data bus.
18	D5	Data bus.
19	D6	Data bus.
20	D7	Data bus.
21	D8	Data bus.
22	D9	Data bus.



Pin No.	Symbol	Function
24	D11	Data bus.
25	D12	Data bus.
26	D13	Data bus.
27	D14	Data bus.
28	D15	Data bus.
29	NC	Not Connect
30	NC	Not Connect
31	NC	Not Connect
32	NC	Not Connect
33	NC	Not Connect
34	NC	Not Connect
35	NC	Not Connect
36	NC	Not Connect
37	NC	Not Connect
38	NC	Not Connect
39	NC	Not Connect
40	NC	Not Connect



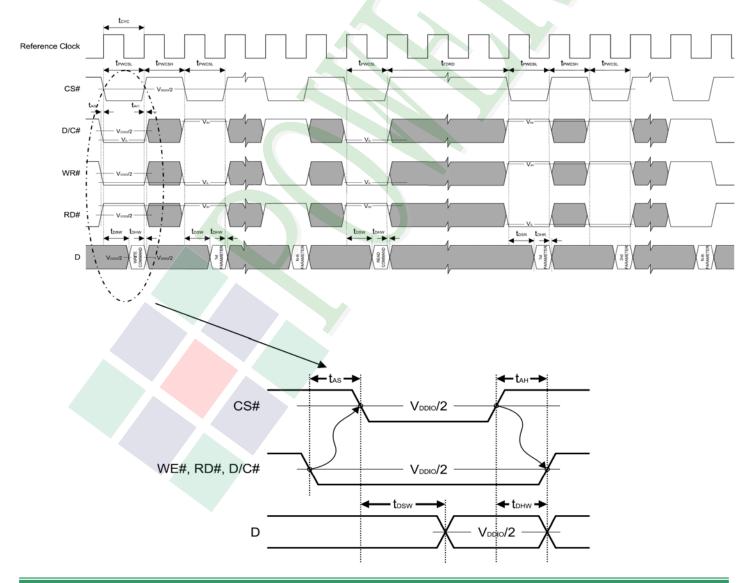
2.3 Timing Characteristics

2.3.1 8080 Mode

8080 Mode Timing

Symbol	Parameter	Min	Тур	Max	Unit
t _{cyc}	Reference Clock Cycle Time	9	-		ns
t _{PWCSL}	Pulse width CS# low	1	-	,	t _{CYC}
t _{PWCSH}	Pulse width CS# high	1	•	•	t_{CYC}
t_{FDRD}	First Read Data Delay	5	-	-	t _{CYC}
t _{AS}	Address Setup Time	1	-	•	ns
t _{AH}	Address Hold Time	1	-		ns
t _{DSW}	Data Setup Time	4	-	-	ns
t _{DHW}	Data Hold Time	1	-	-	ns
t _{DSR}	Data Access Time	•	-	5	ns
t _{DHR}	Output Hold time	1	-	•	ns

8080 Mode Timing Diagram



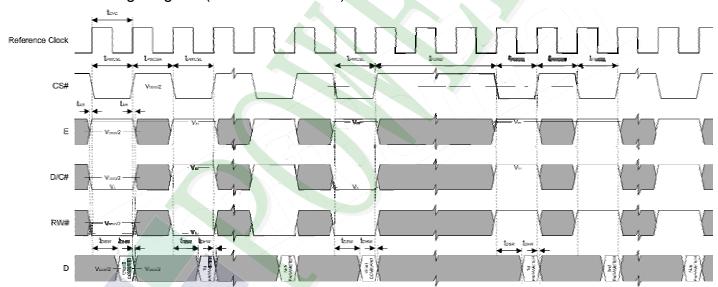


2.3.1 6800 Mode

6800 Mode Timing

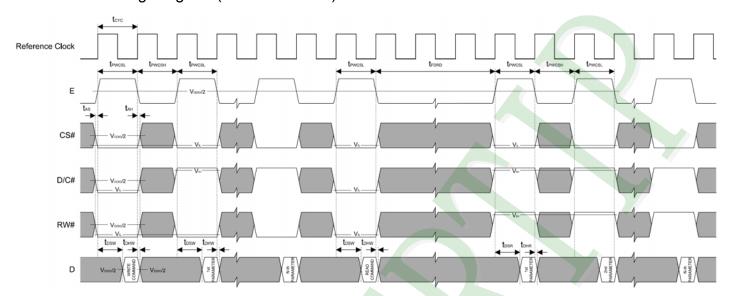
Symbol	Parameter	N	Iin	Typ	Max	Unit
t _{cvc}	Reference Clock Cycle Time	9		-	- /	ns
tpwcsl	Pulse width CS# or E low	1		-	-	t _{CYC}
tpwcsh	Pulse width CS# or E high	1		-	-	t _{CYC}
t _{FDRD}	First Data Read Delay	5		-	-	tcyc
t _{AS}	Address Setup Time	1		-	-	ns
t _{AH}	Address Hold Time	1		-	•	ns
t_{DSW}	Data Setup Time	4		-	-	ns
t_{DHW}	Data Hold Time	1		-	- //	ns
t _{DSR}	Data Access Time	-		-	5	ns
t_{DHR}	Output Hold time	1		-	-	ns

6800 Mode Timing Diagram (Use CS# as Clock)





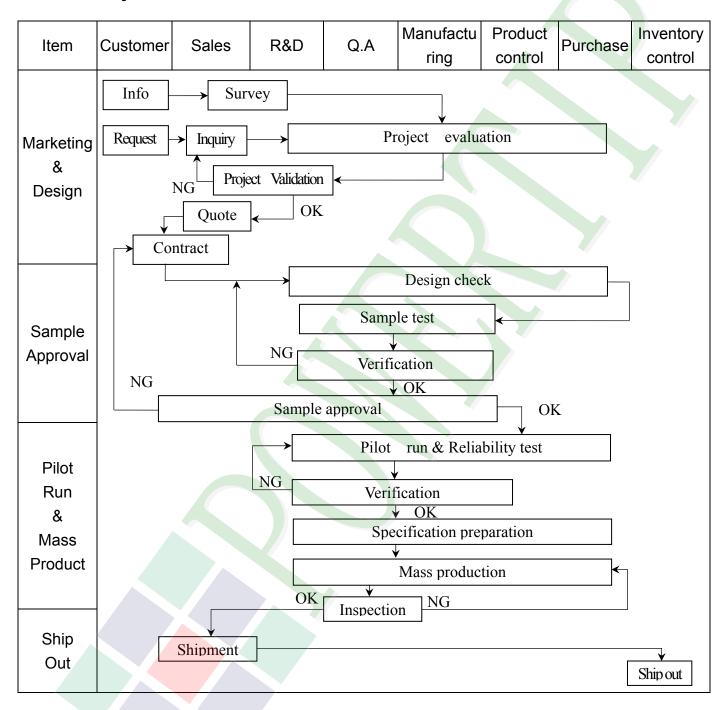
6800 Mode Timing Diagram (Use E as Clock)



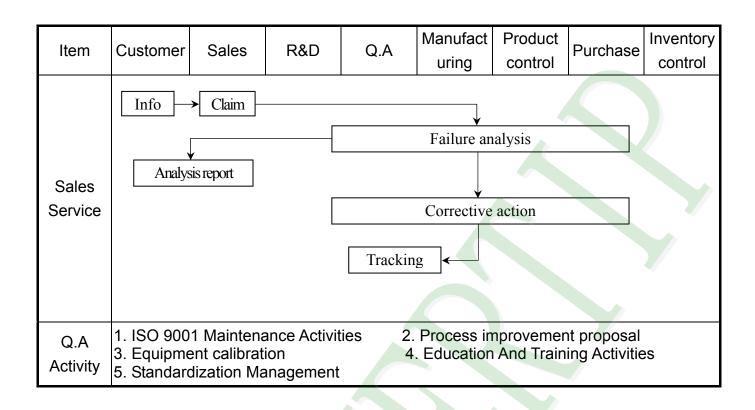


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2. Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" ~10" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment: Gauge · MIL-STD · Powertip Tester · Sample

◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5

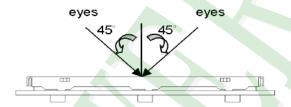
♦OUT Going Defect Level: Sampling.

◆Standard of the product appearance test:

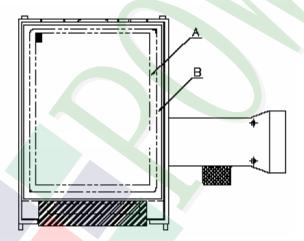
a. Manner of appearance test:

(1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~10":

NO	Item	Criterion	Level		
		1. 1The part number is inconsistent with work order of production.			
01	Product condition	1. 2 Mixed product types.	Major		
		1. 3 Assembled in inverse direction.	Major		
02	Quantity	2. 1The quantity is inconsistent with work order of production.			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major		
		4. 1 Missing line character and icon.	Major		
	Electrical Testing	4. 2 No function or no display.			
04		4. 3 Display malfunction.			
		4. 4 LCD viewing angle defect.			
		4. 5 Current consumption exceeds product specifications.	Major		
		Item Acceptance (Q'ty)			
	Dot defect	Bright Dot ≤ 4			
	Dot delect	Dot Dark Dot ≤ 5			
	(Bright dot \	Defect Joint Dot ≤ 3			
05	Dark dot)	Total ≤ 7	Minor		
	On -display	 5. 1 Inspection pattern: full white, full black, Red, Green and blue screens. 5. 2 It is defined as dot defect if defect area >1/2 dot. 5. 3 The distance between two dot defect ≥5 mm. 			



◆Specification For TFT-LCD Module 3. 5" ~10":

NO	Item	Criterion				
		6. 1 Round type (Non-display or display) :				
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area				
	Black or white dot \ scratch \ contamination	$\Phi \le 0.25$ Ignore	\			
		$0.25 < \Phi \le 0.50$ 5 Ignore				
	Round type → X ← ↓	$\Phi > 0.50 \qquad 0$				
	Y	Total 5				
06	$\Phi = (x+y)/2$ Line type	6. 2 Line type(Non-display or display) :	Minor			
		Length (L) Width (W) Acceptance (Q'ty)				
		A area B area				
	✓ [†] W	W ≤ 0.03 Ignore				
	→ı _L	$L \le 10.0$ $0.03 < W \le 0.05$ 4				
		L ≤ 5.0 0.05 < W ≤ 0.10 2 Ignore				
		W > 0.10 As round type				
		Total 5				
		Dimension (diameter : Φ) Acceptance (Q'ty) A area B area				
		$\Phi \le 0.25$ Ignore				
07	Polarizer Bubble	$0.25 < \Phi \leq 0.50 \qquad \qquad 4$	Minor			
		Bubble	$0.50 < \Phi \le 0.80$ 1 Ignore			
		$\Phi > 0.80$				
		Total 5				



◆Specification For TFT-LCD Module 3. 5" ~10":

NO	Item	Criterion		Level				
		Z: The thickness of crack	Y : The width of crack. W : terminal length a : LCD side length					
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and cra						
08	The crack of glass	SPZ	Z X SP	Minor				
		[OK] Seal width						
		X Y	z					
		≤ a Crack can't enter viewing area ≤1/2 t						
		≤ a Crack can't exceed the half of SP width.	Crack can't exceed the					



◆Specification For TFT-LCD Module 3. 5″ ~10″:

NO	Item	Criterion	Level				
	X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:						
		X Y Z					
		$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t					
		$\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t $<$ Z ≤ 2 t					
08	The crack of glass		Minor				
	The crack of glass	8.2 Protrusion over terminal: 8.2.1 Chip on electrode pad:	Willion				
		W.Y. Z. X. Y. Z. X. X. Y. Z. X. X. Y. Z. X. X. Y. Z. X. X. X. X. Z. X.					
		X Y Z					
		Front $\leq a$ $\leq 1/2 \mathrm{W}$ $\leq t$					
		Back \leq a \leq W \leq 1/2 t					



◆Specification For TFT-LCD Module 3. 5″ ~10″: (Ver.B01)

NO	Itom	Cuitavian	Lovel
	Hem		Level
08	The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 3. 2. 2 Non-conductive portion: X: The width of crack. W: terminal length a: LCD side length 8. 2. 2 Non-conductive portion: X: Y: The width of crack. W: terminal length a: LCD side length 8. 2. 2 Non-conductive portion: X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length X: Y: The width of crack. W: terminal length a: LCD side length Standard M: LCD side length a: LCD side length a: LCD side length but A: LCD side length a: LCD side length but A: LCD side length a: LCD side length but A: LCD side length a: LCD side length but A: LCD side length but A: LCD side length but A: LCD side length a: LCD side length but A: LCD s	Minor



◆Specification For TFT-LCD Module 3. 5″ ~10″:

NO	Item	Criterion	Level
09	Backlight elements	9. 1 Backlight can't work normally.	Major
		9. 2 Backlight doesn't light or color is wrong.	Major
		9, 3 Illumination source flickers when lit.	Major
	diagram. 10. 2 No short circuits in component 10. 3 Parts on PCB or FPC must production characteristic characteristic characteristic parts, missing parts or excess General appearance 10. 4 Product packaging must the sample specification sheet. 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in page 10. 5 The folding and peeled off in	10. 1 Pin type \ quantity \ dimension must match type in structure diagram.	Major
		10. 2 No short circuits in components on PCB or FPC.	Major
		10. 3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
10		10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

	Tenability Test 90	<u> </u>		<u>'</u>	(VCI.DOI)		
NO.	TEST ITEM		TEST CO	NDITION			
1	High Temperature	Keep in+80	±2°C 96 hrs				
1	Storage Test	Surrounding	Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature	Keep in -30 ±2°C 96 hrs					
	Storage Test	Surrounding	g temperature, then sto	rage at normal conditio	n 4hrs.		
	High Temperature /	Keep in +60°C / 90% R.H duration for 96 hrs					
3	High Humidity	Surrounding temperature, then storage at normal condition 4hrs.					
	Storage Test	(Excluding the polarizer)					
			-30°C → +25°C -	\rightarrow +80°C \rightarrow +25°C			
4	Temperature Cycling		(30mins) (5mins)	(30mins) (5mins)			
4	Storage Test		10 C	ycle			
		Surrounding	g temperature, then sto	rage at normal conditio	n 4hrs.		
	ESD Test	Air Dischar	ge:	Contact Discharge:			
		Apply 2 KV	with 5 times	Apply 250 V with 5 tin	nes		
		Discharge fo	or each polarity +/-	discharge for each pola	rity +/-		
		1. Temperature ambiance : 15°C ~35°C					
5		2. Humidity relative: 30%~60%					
		3. Energy Storage Capacitance(Cs+Cd): 150pF±10%					
		4. Discharge Resistance(Rd): 330 Ω±10%					
			ge, mode of operation :				
				iccessive discharges at	least 1 sec)		
		(Tolerance if the output voltage indication: ±5%)					
_	Vibration Test		$\sim 10 \sim 55$ Hz frequency	• • • • • • • • • • • • • • • • • • • •			
6	(Packaged)	-	olitude of vibration:1.5				
	(3. Each di	rection (X \ Y \ Z) dura	ation for 2 Hrs			
			Packing Weight (Kg)	Drop Height (cm)			
			0 ~ 45.4	122			
	Drop Test		45.4 ~ 90.8	76			
7	(Packaged)		90.8 ~ 454	61			
			0ver 454	46			
		Dwan Ding -4	ion • W1 agrees / 9 - 4	us / C sidos os sk 14ims -	'		
		Drop Direct	ion :※1 corner / 3 edge	es / o sides each Itime			



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

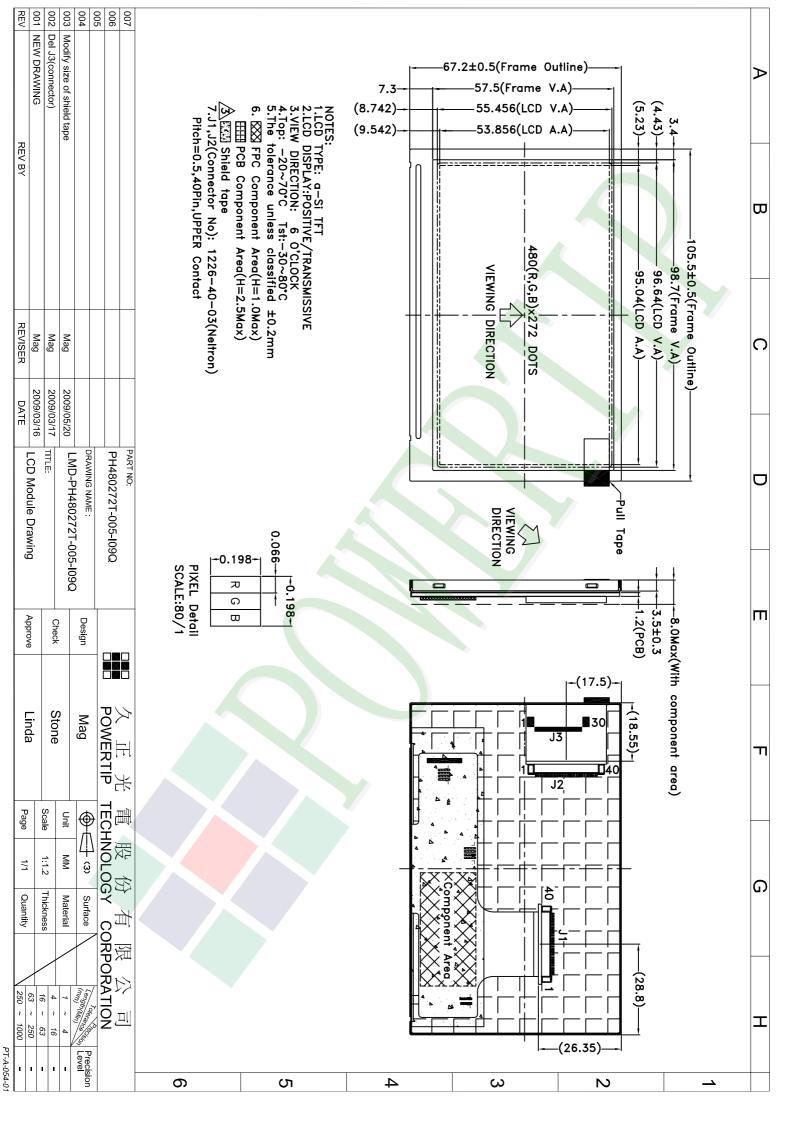
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 Linda Stone Mag LCM Packaging Specifications Documents NO. PKG-PH480272T-005-I09Q 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PH480272T-005-I09Q 105.5 X 67.2 1 成品 (LCM) 0.07 84 5.88 氣泡袋(1)Bubble Bag 0.0045 84 2 170 X 150 BAG170150BRABA 0.378 42. 3 A4隔板(2)A4 Partition 245 X 70 X 2.5 0.014 BX24500070BNBA 1.092 B4隔板(3)B4 Partition 293 X 70 X 2.5 0.012 12 4 BX29300070BLBA 0.144 5 海綿墊(4)Foam Rubber Cushion OTFOAM00006ABA 290 X 240 X 10 0.02 12 0.24 0.263 6 6 C3內盒(5)Product Box BX31025510AABA 310 X 255 X 100 1.578 7 外紙箱(6)Carton 527 X 325 X 360 1.092 BX52732536CCBA 1 1.092 8 9 整箱總重量 (Total LCD Weight in carton): 10.4 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)Quantity Of Spacer: A4隔板 X 7, B4隔板 X 2 (2)Total LCM quantity in carton: quantity per box x no of boxes 84 (5) 海綿墊 Foam Rubber Cushion (1)靜電袋+(2)氣泡袋+LCM Antistatic Bag+Bubble Bag+LCM (3) A4隔板-A4 Partition (4) B4隔板 **B4** Partition 仆 (5) 海綿墊 Foam Rubber Cushion (7)外紙箱 Carton (6)C3內盒 Product Box 記 事 特 項 (REMARK) 2. 每隔放兩片模組,前後隔各放一片模組。 3.放置格示意圖: 1. Label Specifications: (如3.放置格示意圖) 3.Each divider is placed inside a product Box 2. 2 LCM are placed on every. The first and MODEL: the last slot should be one pcs LOT NO: (See remarks 3 on packaging specifications) QUANTITY: CHECK: